

2nd TCT Workshop – Ljubljana, October 17 2016

Laboratory results on LGADs

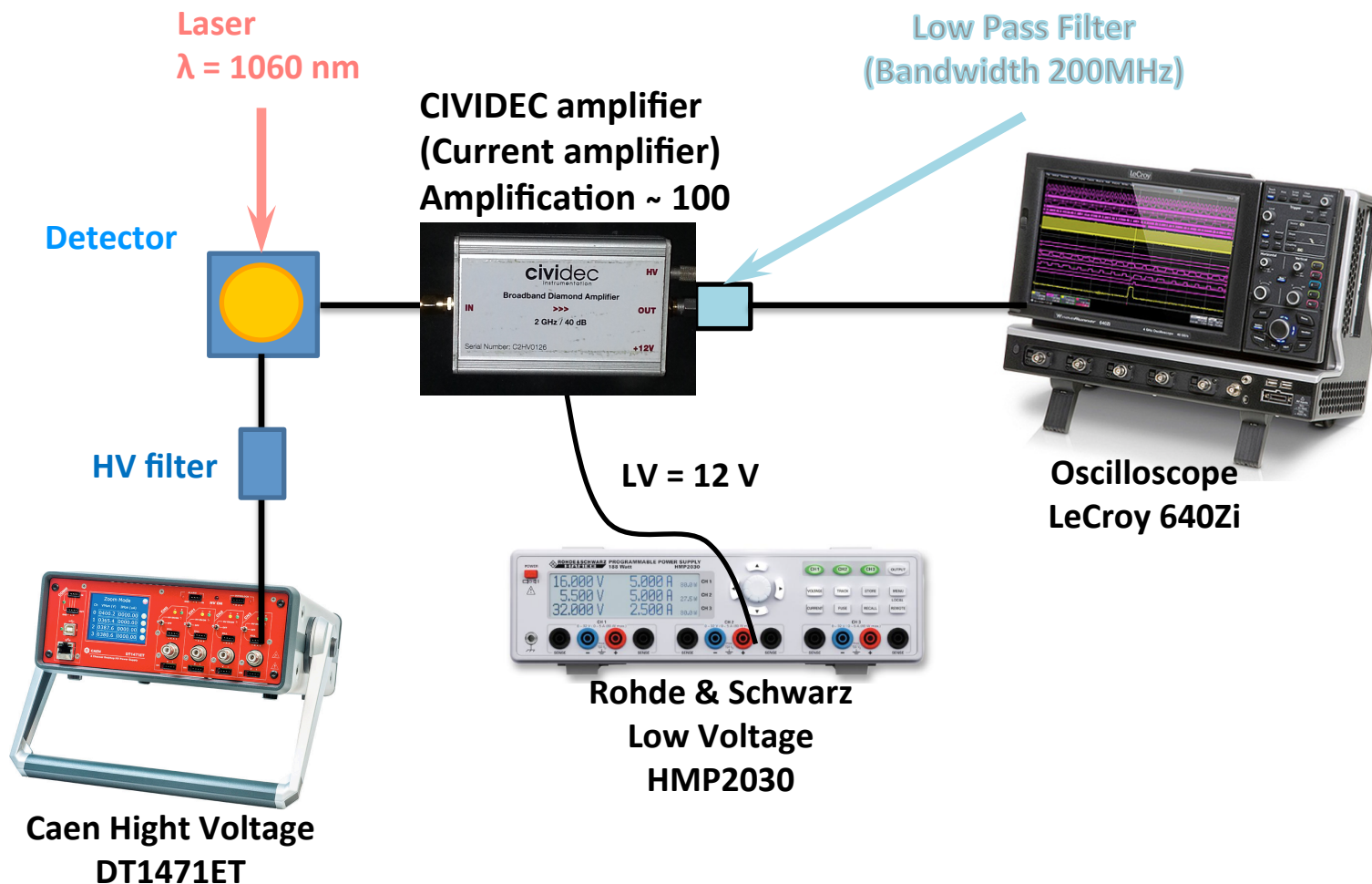
Marco Ferrero at. All



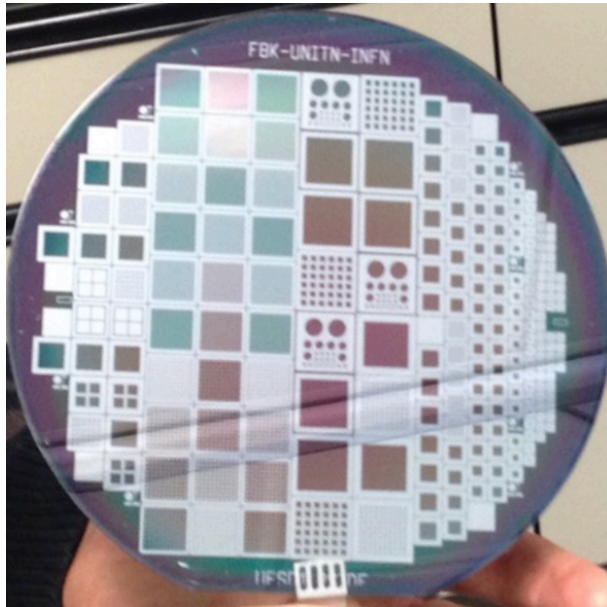
Outline

- Gain measurements:
 - CNM sensors (300 μ m and 50 μ m);
 - FBK sensors (300 μ m);
- Evaluation of the time resolution Jitter and Landau components:
 - Simulation;
 - Beam test and Laboratory measurements comparison;

Laboratory laser setup

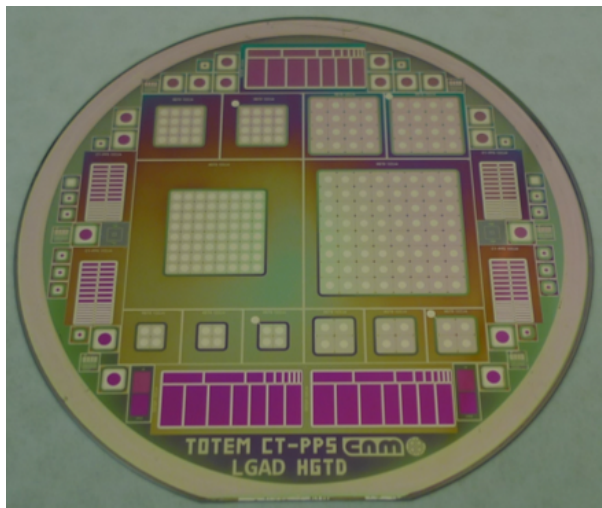


FBK & CNM Sensors



FBK Production:

- Thickness 300 μ m;
- 13 Wafers produced;
- 5 Splits of gain in 2% steps;
- Multiple structures (single pad, multi-pad, array, strip);
- n-side segmentation;
- p-side segmentation;

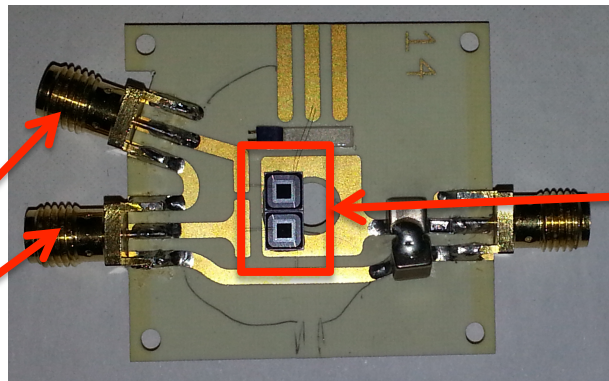


CNM Production (Run 9088):

- SOI wafers
- Thickness 50 μ m;
- 3 Gain Doses:
 - $1,8 \cdot 10^{13} \text{cm}^{-2}$
 - $1,9 \cdot 10^{13} \text{cm}^{-2}$
 - $2,0 \cdot 10^{13} \text{cm}^{-2}$

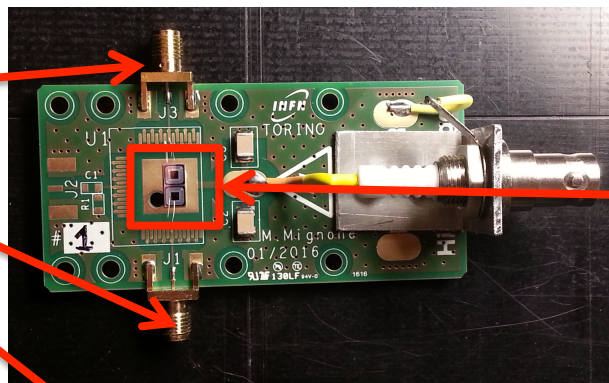
FBK Sensors tested

Read out channels



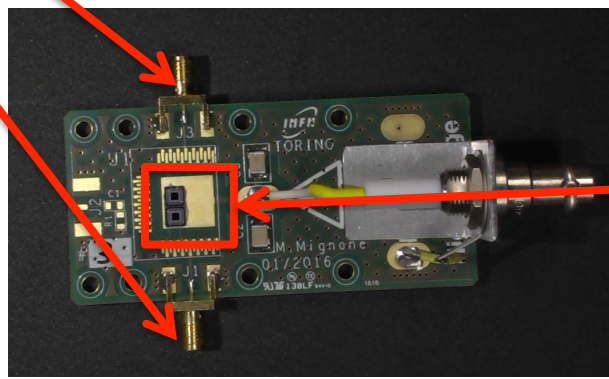
PCB developed by CERN

Wafer 3-Split 2 of gain
Detector Single Pad
(LGAD + DIODE)
Area 4 mm²
Thickness = 300μm



PCB developed by INFN, Turin (Marco Mignone)

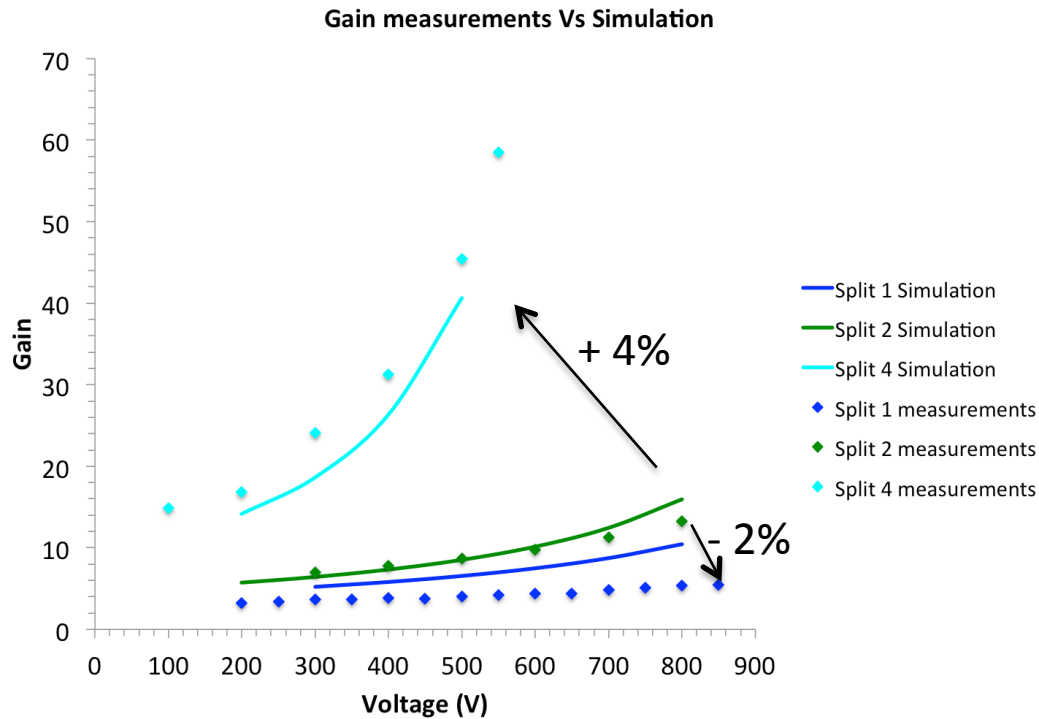
Wafer 10-Split 4 of gain
Detector Single Pad
(LGAD + DIODE)
Area 4 mm²
Thickness = 300μm



PCB developed by INFN, Turin (Marco Mignone)

Wafer 1-Split 1 of gain
Detector Single Pad
(LGAD + DIODE)
Area 4 mm²
Thickness = 300μm

Gain Measurements Vs Simulations (FBK Sensors)



Gain = LGAD area signal/DIODE area signal

Measurements

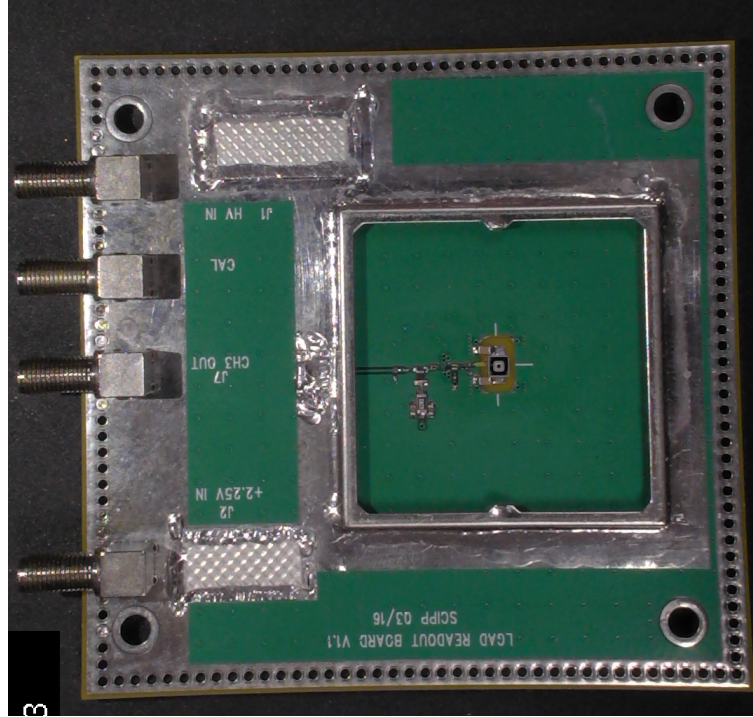
- Laser attenuation to replicate 1 MIP in agreement with Weightfield2;
- Ideal condition (laser in the center of the pad);
- Laser wavelength = 1060 nm
- Measurements performed at room temperature (about 300K);
- Laser not focalized;

Simulations

- TCAD Simulation;
- IR Laser;
- Simulations performed with diffusive optical generation;
- Temperature Simulations = 300K;

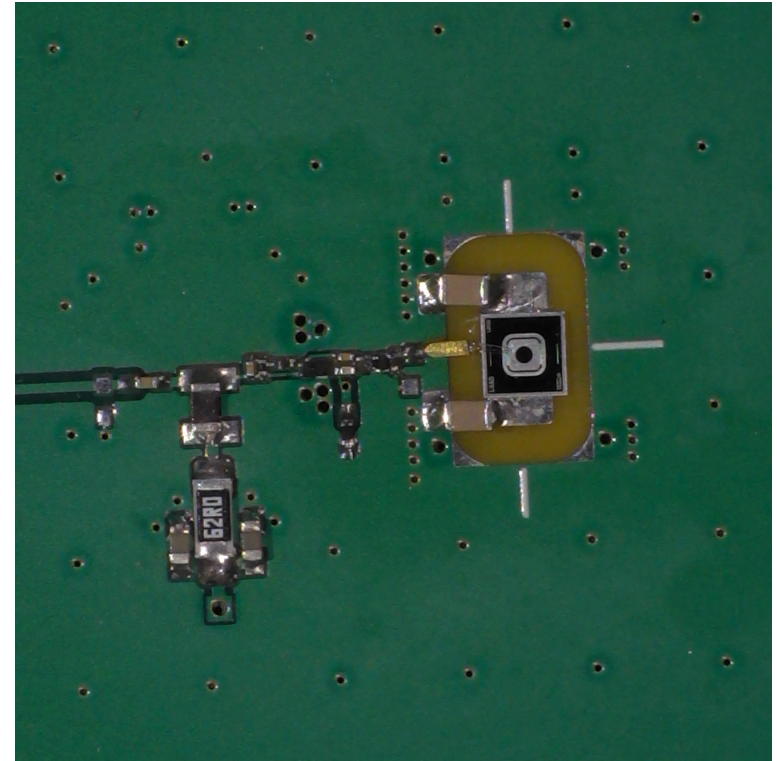
***The Simulations was performed by
Lucio Pancheri of the University of
Trento.***

CNM Sensors tested



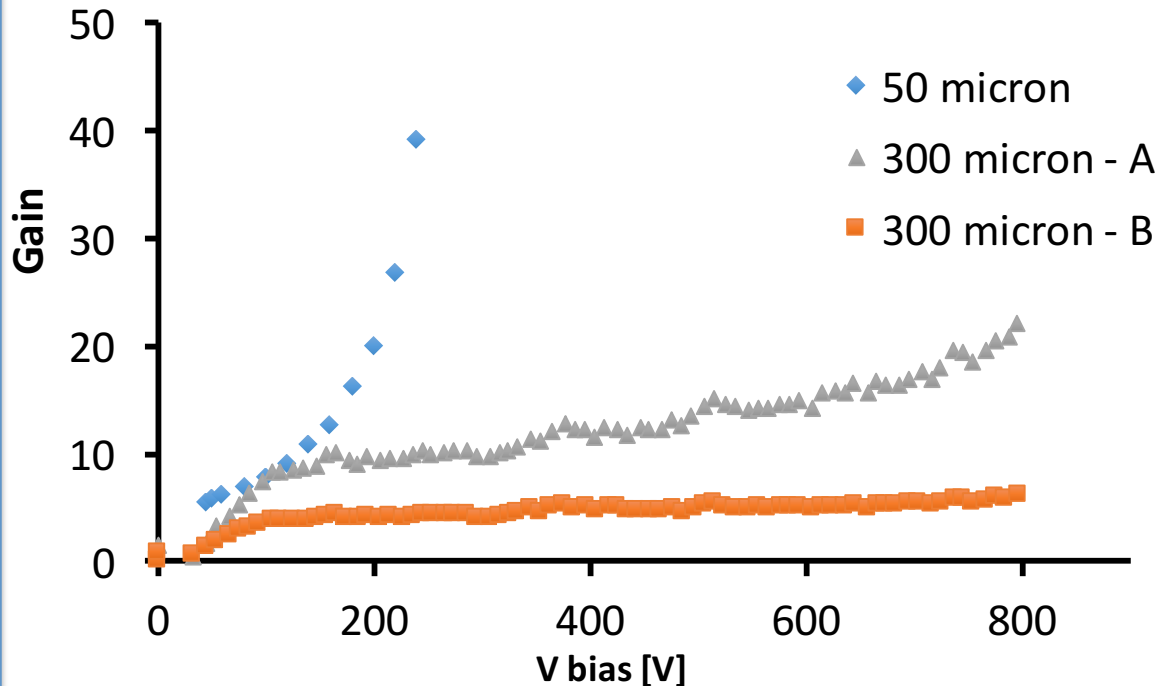
SantaCruz Board

CNM Run 9088-Wafer 5
Gain Dose $1,9 \cdot 10^{13} \text{cm}^{-2}$
Detector Single Pad
Area $1,7 \text{ mm}^2$
Thickness = $50 \mu\text{m}$



Gain Measurements (CNM Sensors)

LGAD gain as a function of the bias voltage
3 CNM productions: 50 and 300 micron sensors



Measurements:

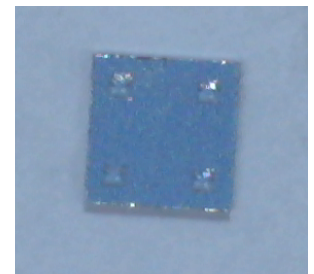
- Measurements of gain performed in Santacruz;
- B Source ^{90}Sr ;
- 50 μm Sensors of the wafer 5 (Dose = $1,9 \cdot 10^{13} \text{cm}^{-2}$;

ISSUE:

The metallization on the back of the sensor doesn't permit to perform the same measurement using a laser source.

Laser reflection

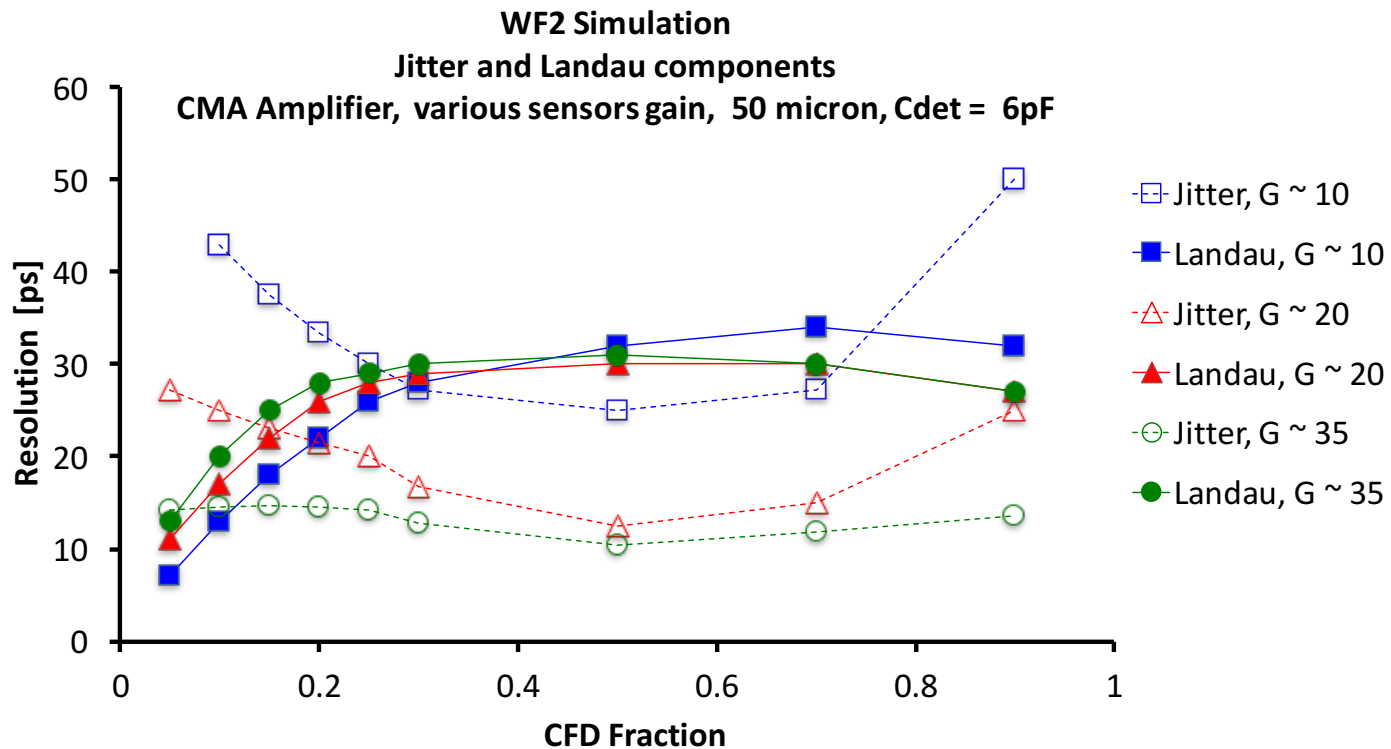
Sensor back plate metallization



Time resolution

Jitter and Landau components

$$\sigma_t^2 = \sigma_{\text{jitter}}^2 + \sigma_{\text{landau}}^2 + \sigma_{\text{TDC}}^2$$



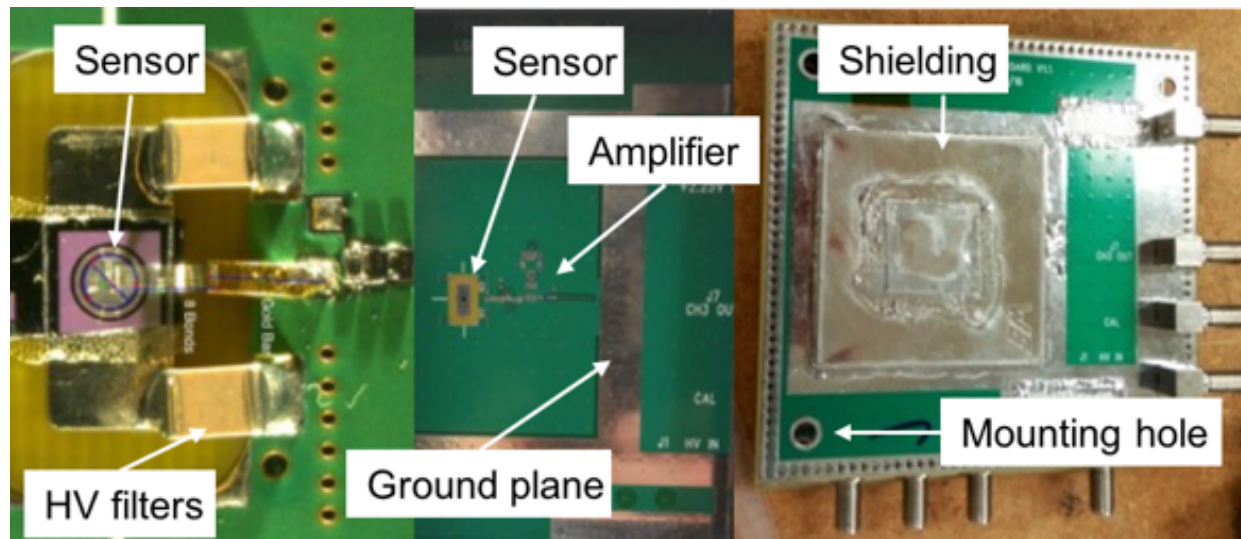
Weightfield2 Simulations

- 50 μ m Sensors;
- Cdet = 6pF;
- Sensor with various gain (10-20-35)

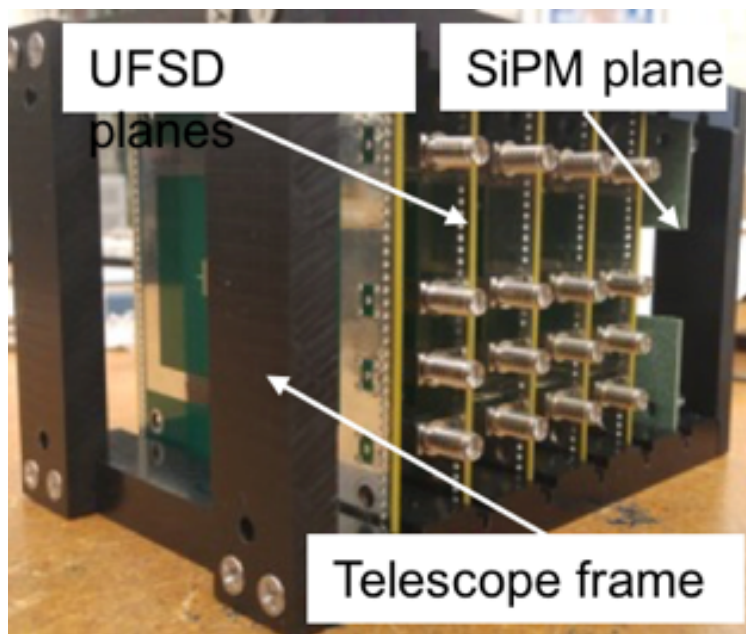
Jitter components decrease with the gain increasing

Landau component predominates over the Jitter for high gain and CFD

Beam test setup



Fully custom made
UFSD readout (UCSC)

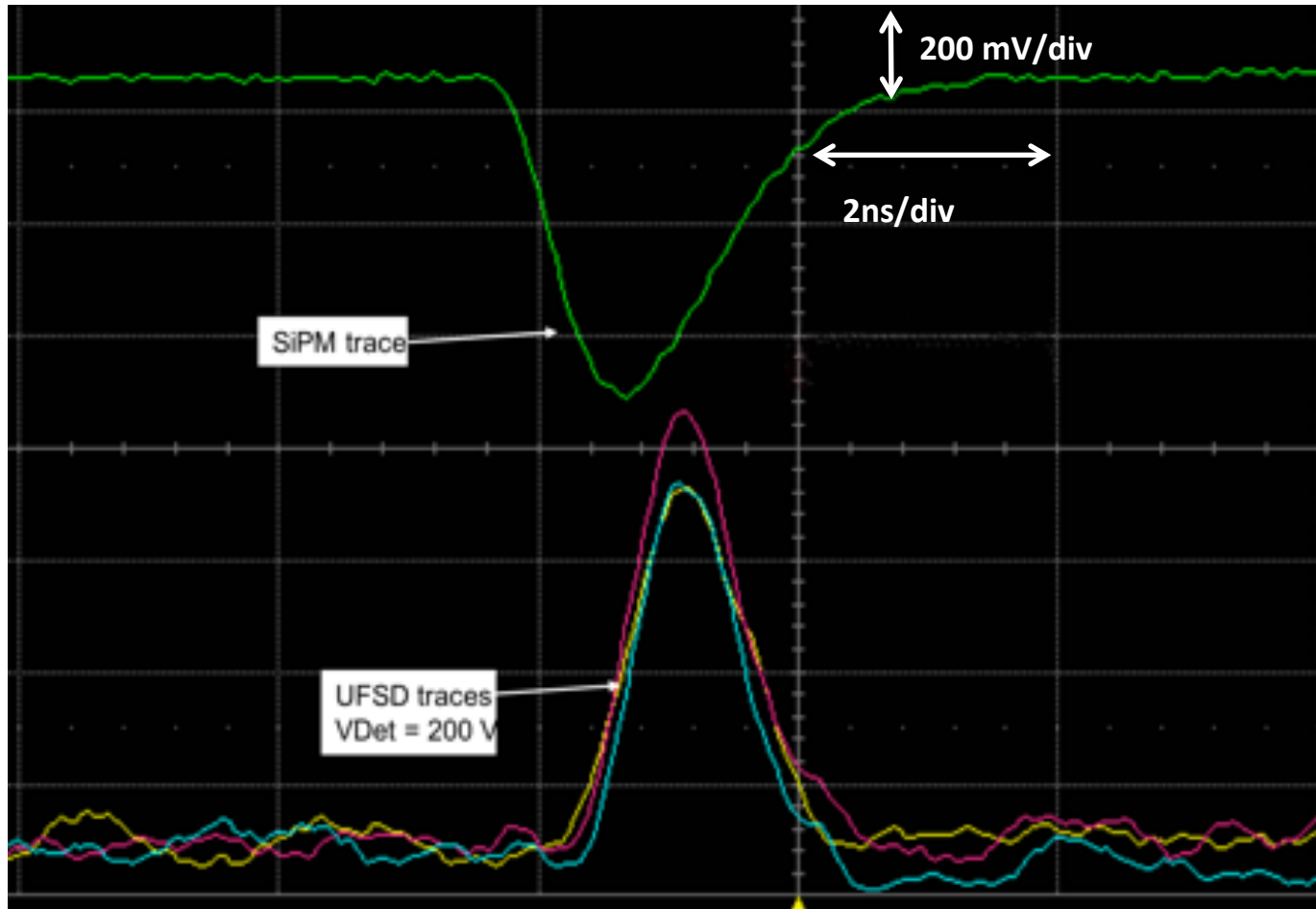


CNM production
of thin sensors
50 μm

**Beam Test @ SPS H8 area
(180 GeV/c pions)**

Beam test signal example

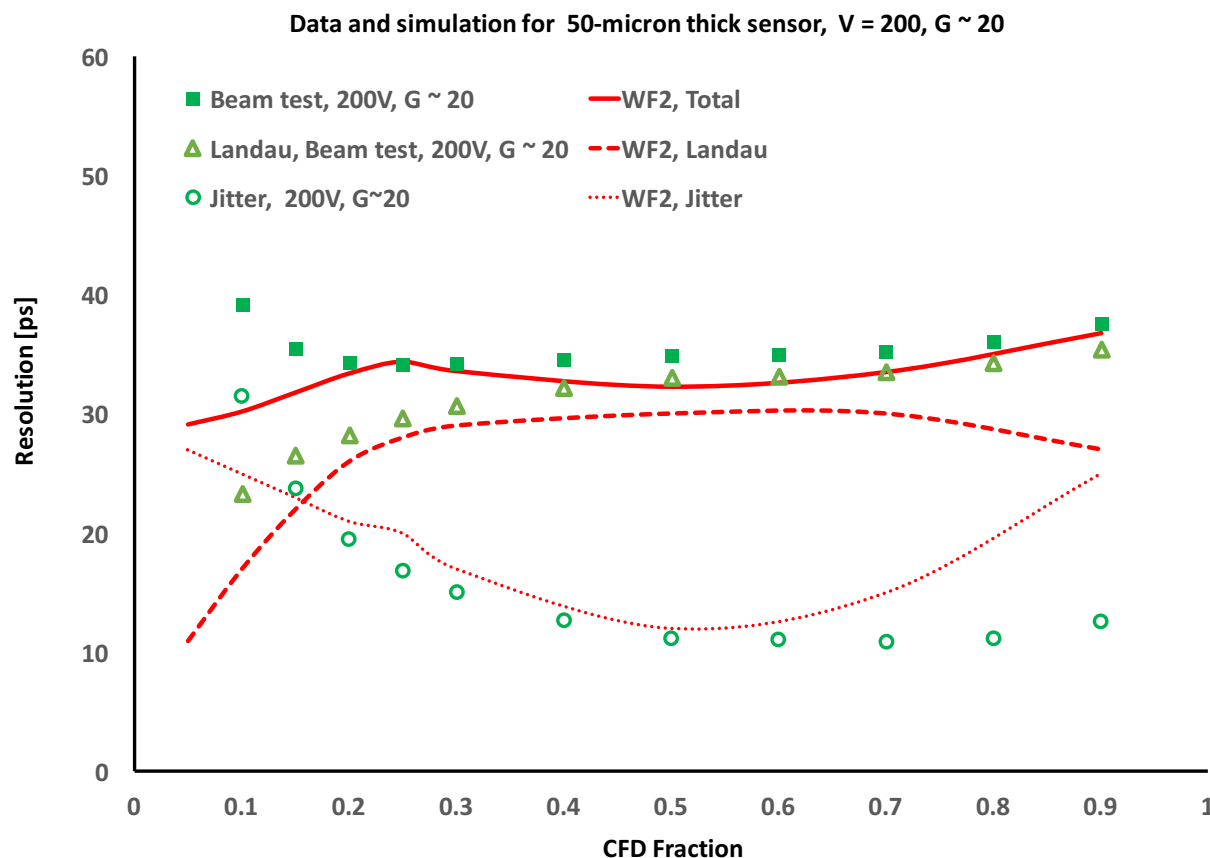
Fast, low noise signal, ideal for timing



Time resolution-Jitter and Landau components

Data Vs Simulation

$$\sigma_t^2 = \sigma_{\text{jitter}}^2 + \sigma_{\text{landau}}^2 + \sigma_{\text{TDC}}^2$$



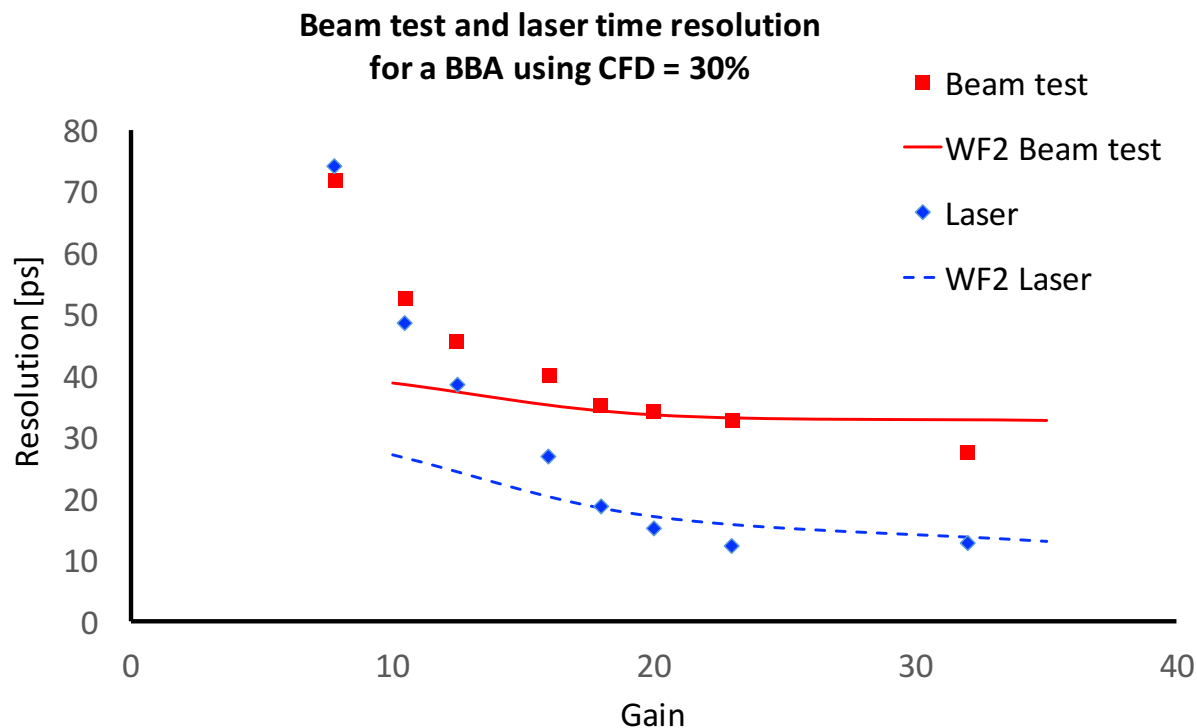
- Beam test data has jitter and Landau contribution
- Laser data has only Jitter contribution

The landau contribution was extrapolated by the beam test and laser data

Good agreement
between weightfield2
simulations and
experimental data

Time resolution-Beam Test and Laser

$$\sigma_t^2 = \sigma_{\text{jitter}}^2 + \sigma_{\text{landau}}^2 + \sigma_{\text{TDC}}^2$$



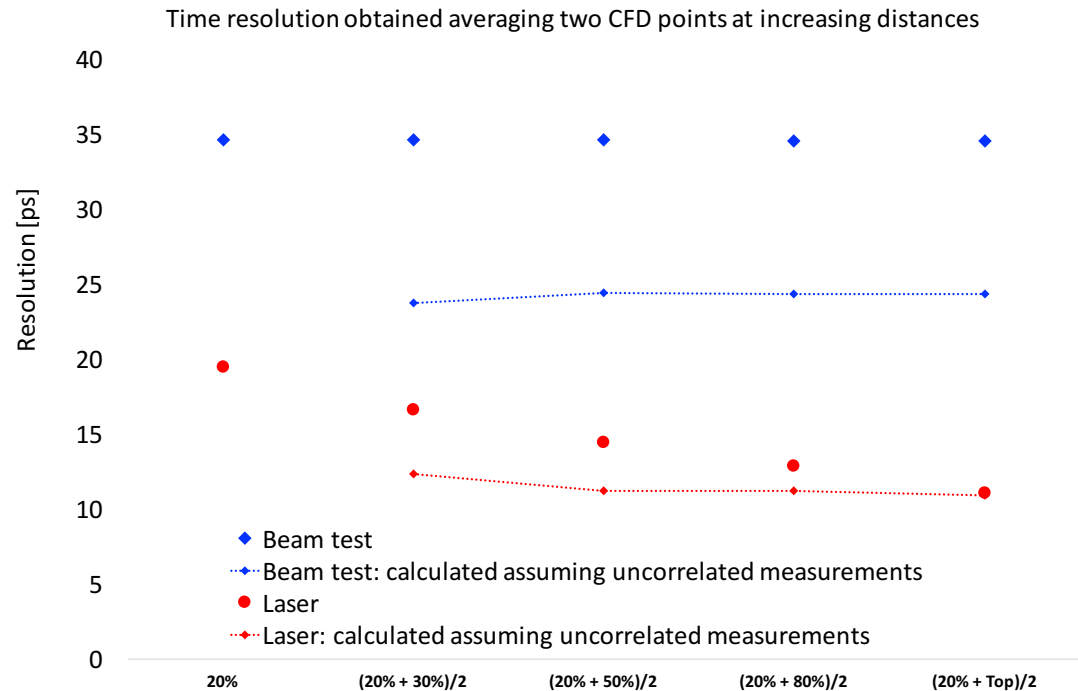
Time resolution is flat for
high value of gain

The different between
beam test and laser data
is due to only the landau
fluctuation

Good agreement
between weightfield2
simulations and
experimental data

Correlation between time resolution and Jitter/Landau fluctuation

Landau fluctuation cause a correlation for different points of the rising edge of the signal?



The beam test data (Landau) are correlated for all the rising edge of the signal (~400ps):

The Time Resolution of the average of two CFD points is the same of the single CFD point

The laser data (Jitter) are uncorrelated after all the rising edge of the signal (~400ps):

The Time Resolution of the average of two CFD points is better than the single CFD point

Conclusion

Measurements of gain:

- For FBK Sensors the gain measured in laboratory are in agreement with the TCAD simulation;
- For CNM Sensors there is the issue of the metallization that doesn't permit to perform the measurement with laser;

Time resolution:

- The landau fluctuation are predominant than the jitter for sensor with high gain and for CDF above 30%;
- The extrapolation of time resolution landau component and jitter component are in agreement with the Weightfield2 simulation;
- Landau fluctuation induce a correlation between point for all the rising edge of the signal;

Acknowledgements

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- RD50, CERN

Backup

Santacruz Board saturation

